#### ENGINEERING THE PHASE SPEED OF SURFACE–PLASMON WAVE AT THE PLANAR INTERFACE OF A METAL AND A CHIRAL SCULPTURED THIN FILM

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**ABSTRACT** The solution of a boundary–value problem formulated for a modified Kretschmann configuration shows that the phase speed of a surface–plasmon wave guided by the planar interface of a sufficiently thin metal film and a chiral sculptured thin film (STF) depends on the vapor incidence angle used while fabricating the chiral STF by physical vapor deposition. Therefore, it may be possible to engineer the phase speed quite simply by selecting an appropriate value of the vapor deposition angle (in addition to the metal and the evaporant species).

**Keywords:** Kretschmann configuration, metal optics, sculptured thin film, structural handedness, surface plasmon

## 1. INTRODUCTION

The solution of a boundary–value problem formulated for a modified Kretschmann configuration has recently shown that a surface–plasmon wave can exist at the pla-

nar interface of a sufficiently thin metal film and a nondissipative structurally chiral medium, provided the exciting plane wave is p-polarized [1]. Surface-plasmon waves in the visible and the near-infrared regimes are being exploited nowadays for sensing, imaging, and other applications [2, 3, 4, 5]. Structurally chiral mediums exist as chiral nematic and chiral smectic liquid crystals [6] as well as chiral sculptured thin films (STFs) [7].

In addition to their structural handedness (left or right) and their structural period along the axis of helicoidal nonhomogeneity, chiral nematic liquid crystals are characterized by two relative permittivity scalars:  $\epsilon_a$  and  $\epsilon_b$ . Chiral smectic liquid crystals and chiral sculptured thin films, however, are characterized by three relative permittivity scalars ( $\epsilon_a$ ,  $\epsilon_b$ , and  $\epsilon_c$ ) as well as a tilt angle  $\chi \in [0, \pi/2]$ . Our focus here is on chiral STFs, which are fabricated by physical vapor deposition [7].

The constitutive parameters of a chiral STF can be substantially engineered by controlling a few deposition variables. While a chiral STF is being grown on a planar substrate, its structural handedness and structural period are controlled by substrate rotation, whereas a vapor incidence angle  $\chi_v \in (0, \pi/2]$  largely controls  $\epsilon_{a,b,c}$  and  $\chi$ . Therefore, it may be possible to engineer the phase speed of a surface-plasmon wave at the planar interface of a thin metal film and a chiral STF in the Kretschmann configuration [8] quite simply by selecting an appropriate value of  $\chi_v$  (and the metal as well as the evaporant species, of course).

That thought engendered this communication. Section 2 contains a brief description of a modified Kretschmann configuration, wherein the combination of the metal film and the chiral STF is sandwiched between two half–spaces occupied by the same isotropic dielectric material that is optically denser than the chiral STF [1]. Section 3 contains numerical results to show that a higher value of the vapor incidence angle reduces the phase speed of the surface–plasmon wave and increases the conversion efficiency of the exciting plane wave into the surface–plasmon wave.

In the following sections, an  $\exp(-i\omega t)$  time-dependence is implicit, with  $\omega$  denoting the angular frequency. The free-space wavenumber, the free-space wavelength, and the intrinsic impedance of free space are denoted by  $k_0 = \omega \sqrt{\epsilon_0 \mu_0}$ ,  $\lambda_0 = 2\pi/k_0$ , and  $\eta_0 = \sqrt{\mu_0/\epsilon_0}$ , respectively, with  $\mu_0$  and  $\epsilon_0$  being the permeability and permittivity of free space. Vectors are in boldface, dyadics underlined twice; column vectors are in boldface and enclosed within square brackets, while matrixes are underlined twice and similarly bracketed. Cartesian unit vectors are identified as  $\hat{\mathbf{u}}_x$ ,  $\hat{\mathbf{u}}_y$  and  $\hat{\mathbf{u}}_z$ .

### 2. THEORY IN BRIEF

In conformance with the Kretschmann configuration for launching surface-plasmon waves, the half-space  $z \leq 0$  is occupied by a homogeneous, isotropic, dielectric material described by the relative permittivity scalar  $\epsilon_{\ell}$ . Dissipation in this material is considered to be negligible and its refractive index  $n_{\ell} = \sqrt{\epsilon_{\ell}}$  is real-valued and positive. The laminar region  $0 \leq z \leq L_{met}$  is occupied by a metal with relative permittivity scalar  $\epsilon_{met}$ . Without significant loss of generality in the present context, the half-space  $z \geq L_{met} + L_{stf}$  is taken to be occupied by the same material as fills the half-space  $z \leq 0$ .

A chiral STF occupies the region  $L_{met} \leq z \leq L_{met} + L_{stf}$ . Its relative permittivity dyadic  $\underline{\epsilon}_{stf}(z)$  is factorable as

$$\underline{\underline{\epsilon}}_{stf}(z) = \underline{\underline{S}}_{z}(z - L_{met}) \cdot \underline{\underline{S}}_{y}(\chi) \cdot \underline{\underline{\epsilon}}_{stf}^{ref} \cdot \underline{\underline{S}}_{y}^{T}(\chi) \cdot \underline{\underline{S}}_{z}^{T}(z - L_{met}),$$

$$L_{met} \leq z \leq L_{met} + L_{stf},$$
(1)

where the reference relative permittivity dyadic

$$\underline{\epsilon}_{\underline{s}tf}^{ref} = \epsilon_a \, \hat{\mathbf{u}}_z \hat{\mathbf{u}}_z + \epsilon_b \, \hat{\mathbf{u}}_x \hat{\mathbf{u}}_x + \epsilon_c \, \hat{\mathbf{u}}_y \hat{\mathbf{u}}_y \,. \tag{2}$$

The dyadic function

$$\underline{\underline{S}}_{z}(z) = (\hat{\mathbf{u}}_{x}\hat{\mathbf{u}}_{x} + \hat{\mathbf{u}}_{y}\hat{\mathbf{u}}_{y})\cos\left(h\frac{\pi z}{\Omega}\right) + (\hat{\mathbf{u}}_{y}\hat{\mathbf{u}}_{x} - \hat{\mathbf{u}}_{x}\hat{\mathbf{u}}_{y})\sin\left(h\frac{\pi z}{\Omega}\right) + \hat{\mathbf{u}}_{z}\hat{\mathbf{u}}_{z}, \quad (3)$$

contains 2 $\Omega$  as the structural period and  $h = \pm 1$  as the structural-handedness parameter. The tilt dyadic

$$\underline{\underline{S}}_{y}(\chi) = (\hat{\mathbf{u}}_{x}\hat{\mathbf{u}}_{x} + \hat{\mathbf{u}}_{z}\hat{\mathbf{u}}_{z})\cos\chi + (\hat{\mathbf{u}}_{z}\hat{\mathbf{u}}_{x} - \hat{\mathbf{u}}_{x}\hat{\mathbf{u}}_{z})\sin\chi + \hat{\mathbf{u}}_{y}\hat{\mathbf{u}}_{y}$$
(4)

involves the angle  $\chi \in [0, \pi/2]$ . The superscript <sup>T</sup> denotes the transpose.

A *p*-polarized plane wave, propagating in the half-space  $z \leq 0$  at an angle  $\theta \in [0, \pi/2)$  to the *z* axis and at an angle  $\psi \in [0, 2\pi)$  to the *x* axis in the *xy* plane, is incident on the metal-coated chiral STF. The electric field phasor associated with the incident plane wave is

$$\mathbf{E}_{inc}(\mathbf{r}) = \mathbf{p}_{+} e^{i\kappa(x\cos\psi + y\sin\psi)} e^{ik_{0}n_{\ell}z\cos\theta}, \qquad z \le 0.$$
(5)

The reflected electric field phasor is expressed as

$$\mathbf{E}_{ref}(\mathbf{r}) = (r_s \,\mathbf{s} + r_p \,\mathbf{p}_-) \,e^{i\kappa(x\cos\psi + y\sin\psi)} \,e^{-ik_0 n_\ell z\cos\theta}, \qquad z \le 0, \tag{6}$$

and the transmitted electric field phasor as

$$\mathbf{E}_{tr}(\mathbf{r}) = (t_s \,\mathbf{s} + t_p \,\mathbf{p}_+) \, e^{i\kappa(x\cos\psi + y\sin\psi)} \, e^{ik_0 n_\ell(z - L_{met} - L_{stf})\cos\theta} \,, \qquad z \ge L_{met} + L_{stf} \,. \tag{7}$$

Here,

$$\kappa = k_0 n_\ell \sin \theta$$
  

$$\mathbf{s} = -\hat{\mathbf{u}}_x \sin \psi + \hat{\mathbf{u}}_y \cos \psi$$
  

$$\mathbf{p}_{\pm} = \mp (\hat{\mathbf{u}}_x \cos \psi + \hat{\mathbf{u}}_y \sin \psi) \cos \theta + \hat{\mathbf{u}}_z \sin \theta$$
(8)

where  $\omega/\kappa$  is the phase speed parallel to the interfacial plane  $z = L_{met}$  of interest, and the unit vectors **s** and  $\mathbf{p}_{\pm}$  denote the *s*- and the *p*-polarization states of the electric field phasors.

The reflection amplitudes  $r_s$  and  $r_p$ , as well as the transmission amplitudes  $t_s$  and  $t_p$ , have to be determined by the solution of a boundary-value problem. The required procedure is standard [7, Chap. 10], and is discussed in some detail in the predecessor paper [1]. The quantity of interest is the absorbance

$$A_p = 1 - \left( |r_s|^2 + |r_p|^2 + |t_s|^2 + |t_p|^2 \right) \,. \tag{9}$$

#### 3. RESULTS AND DISCUSSION

Although chiral STFs may be made by evaporating a wide variety of materials [7, Chap. 1], the constitutive parameters of chiral STFs have not been extensively measured. However, the constitutive parameters of certain columnar thin films (CTFs) are known. Both CTFs and chiral STFs are fabricated by physical vapor deposition. The basic procedure to deposit CTFs has been known for more than a century [7, 9]. At low enough temperature and pressure, a solid material confined in a boat evaporates towards a stationary substrate. The vapor flux is collimated into a well-defined beam, and its average direction is quantified by the angle  $\chi_v \in (0, \pi/2]$  with respect to the substrate plane. Provided the adatom mobility is low, the resulting film turns out to be an assembly of parallel and nominally identical nanorods [10]. The nanorods have elliptical cross-sections and are tilted at an angle  $\chi \geq \chi_v$  with respect to the substrate plane. Equation (1) applies for CTFs also, but after the limit  $\Omega \to \infty$  has been taken. The parameters  $\epsilon_{a,b,c}$  and  $\chi$  have to be functions of  $\chi_v$ , at the very least because the nanoscale porosity of a CTF depends on the direction of the vapor flux [11].

When the substrate is rotated about a normal passing through its centroid at a constant angular velocity of reasonable magnitude, parallel nanohelixes grow instead of parallel nanorods, and a chiral STF is deposited instead of a CTF [12, 13]. Although the substrate is nonstationary, the functional relationships connecting  $\epsilon_{a,b,c}$  and  $\chi$  to  $\chi_v$  for CTFs would substantially apply for chiral STFs, since the vapor incidence angle  $\chi_v$  remains constant during the deposition of films of either kind.

A series of optical characterization experiments on CTFs of the oxides of tantalum, titanium and zirconium at  $\lambda_0 = 633$  nm were carried out some years ago [14]. The results can be put in the following form for the present purposes:

$$\epsilon_{a} = (n_{a0} + n_{a1} v + n_{a2} v^{2})^{2} 
\epsilon_{b} = (n_{b0} + n_{b1} v + n_{b2} v^{2})^{2} 
\epsilon_{c} = (n_{c0} + n_{c1} v + n_{c2} v^{2})^{2} 
\chi = \tan^{-1} (m \tan \chi_{v})$$

$$(10)$$

Here,  $v = \chi_v/(\pi/2)$  is the vapor incidence angle expressed as a fraction of a right angle. Table 1 contains values of the coefficients  $n_{a0}$  to m of CTFs of three different materials. We used these values to compute the numerical results reported in this section. Let us note that although the bulk refractive indexes of all three oxides are quite close to each other, the coefficients  $n_{a0}$  to m of the three types of CTFs are quite different, as indeed are also their constitutive parameters  $\epsilon_{a,b,c}$  [15]. These difference arise, in part, due to the dependence of the growth dynamics of a CTF on the evaporant species [13].

**Table 1.** Coefficients appearing in Eqs. (10), obtained [16] from the experimental findings of Hodgkinson *et al.* [14] on columnar thin films at  $\lambda_0 = 633$  nm.

material	$n_{a0}$	$n_{a1}$	$n_{a2}$	$n_{b0}$	$n_{b1}$	$n_{b2}$	$n_{c0}$	$n_{c1}$	$n_{c2}$	m
tantalum	1.1961	1.5439	-0.7719	1.4600	1.0400	-0.5200	1.3532	1.2296	-0.6148	3.1056
oxide										
titanium	1.0443	2.7394	-1.3697	1.6765	1.5649	-0.7825	1.3586	2.1109	-1.0554	2.8818
oxide										
zirconium	1.2394	1.2912	-0.6456	1.4676	0.9428	-0.4714	1.3861	0.9979	-0.4990	3.5587
oxide										

As can be gleaned from the predecessor paper [1], just a 2-period thick chiral STF should suffice for the excitation of a surface-plasmon wave; hence, we set  $L_{stf} = 4\Omega$  with  $\Omega =$ 200 nm. The absorbance  $A_p$  was calculated as a function of both  $\theta$  and  $\chi_v$  at the free-space wavelength  $\lambda_0 = 633$  nm, for both structurally left-handed (h = -1) and structurally righthanded (h = +1) chiral STFs. The metal was chosen to be aluminum:  $\epsilon_{met} = -56 + i21$  and



Figure 1: Absorbance  $A_p$  as a function of  $\chi_v$  and  $\theta$  when  $\psi = 0^\circ$ ,  $\lambda_0 = 633$  nm, and the incident plane wave is *p*-polarized. The chiral STF is made of tantalum oxide; see Eqs. (10) and Table 1 for  $\epsilon_{a,b,c}$  and  $\chi$  as functions of  $\chi_v$ . Other parameters are as follows:  $\Omega = 200$  nm,  $h = \pm 1$ ,  $L_{stf} = 4\Omega$ ,  $\epsilon_{met} = -56 + i21$ ,  $L_{met} = 15$  nm, and  $\epsilon_{\ell} = 6.656$ .

 $L_{met} = 15$  nm. The two half-spaces were taken to be filled with zinc selenide ( $\epsilon_{\ell} = 6.656$ ), which is optically denser than all three types of chiral STFs considered here.

Figures 1, 2, and 3 show  $A_p$  as a function of  $\theta$  for different values of  $\chi_v$  for chiral STFs made of tantalum oxide, titanium oxide, and zirconium oxide, respectively. For low values of  $\theta$ ,  $A_p$  is small ( $\leq 0.4$ ) in all three figures. As  $\theta$  increases for a fixed value of  $\chi_v$ ,  $A_p$  begins to fluctuate, then records a very high value, and then tends to zero as  $\theta \to \pi/2$ . The sharp  $A_p$ -peak indicates the excitation of a surface-plasmon wave at the interface of the metal and the chiral STF [1].



Figure 2: Same as Fig. 1, except that the chiral STF is made of titanium oxide.

Let  $\theta_{spw}$  denote the value of  $\theta$  at which the surface-plasmon wave is excited. Figure 4 contains plots of  $\theta_{spw}$  versus  $\chi_v$  gleaned from the previous three figures. Clearly, as  $\chi_v$  increases, so does  $\theta_{spw}$  for chiral STFs fabricated with a specific evaporant species. But the wavenumber of the surface-plasmon wave is given by

$$\kappa_{spw} = k_0 n_\ell \sin \theta_{spw} \,. \tag{11}$$



Figure 3: Same as Fig. 1, except that the chiral STF is made of zirconium oxide.



Figure 4:  $\theta_{spw}$  as a function of  $\chi_v$ , when the chiral STF is made of tantalum oxide, titanium oxide, or zirconium oxide. Other parameters are as follows:  $\lambda_0 = 633$  nm,  $\psi = 0$ ,  $\Omega = 200$  nm,  $h = \pm 1$ ,  $L_{stf} = 4\Omega$ ,  $\epsilon_{met} = -56 + i21$ ,  $L_{met} = 15$  nm, and  $\epsilon_{\ell} = 6.656$ .



Figure 5:  $A_p$  at  $\theta = \theta_{spw}$  as a function of  $\chi_v$ , when the chiral STF is made of tantalum oxide, titanium oxide, or zirconium oxide. Other parameters are as follows:  $\lambda_0 = 633 \text{ nm}, \psi = 0, \Omega = 200 \text{ nm}, h = \pm 1, L_{stf} = 4\Omega, \epsilon_{met} = -56 + i21, L_{met} = 15 \text{ nm}, and \epsilon_{\ell} = 6.656.$ 

Hence,  $\kappa_{spw}$  is a monotonically increasing function of  $\chi_v$ , which means that the phase speed

$$v_{spw} = \omega / \kappa_{spw} \tag{12}$$

is a monotonically decreasing function of  $\chi_v$ . This conclusion agrees qualitatively with earlier studies wherein CTFs were considered in lieu of chiral STFs [17, 18].

Figure 5 contains plots of  $A_p$  at  $\theta = \theta_{spw}$  versus  $\chi_v$  gleaned from Figs. 1–3. As  $\chi_v$  increases, the conversion of the incident energy into the energy of the surface–plasmon wave becomes more efficient after an initial drop at very low  $\chi_v$ . There is, however, a threshold value of  $\chi_v$  beyond which the conversion efficiency does not increase appreciably.

Although the numerical results presented in Figs. 1–5 hold strictly for  $\psi = 0$ , we have verified that they do not change substantially for other values of  $\psi$ . Furthermore, the choice of evaporant species affects the characteristics of the surface–plasmon wave, as is evident from the significantly different graphs in Figs. 4 and 5 for titanium–oxide films than for the other two types of films. This is not surprising because the relative permittivity scalars  $\epsilon_{a,b,c}$ of the zirconium–oxide and tantalum–oxide films are close to each other but quite different from those of the titanium–oxide films [15].

In conclusion, selection of a higher vapor incidence angle leads to a lower phase speed of the surface–plasmon wave at the planar interface of a metal film and the chiral sculptured thin film, in the Kretschmann configuration. Concurrently, the conversion efficiency of the exciting plane wave into the surface–plasmon wave is higher. Thus, the characteristics of the surface–plasmon wave can be substantially engineered by the proper selection of the vapor incidence angle.

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